EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S31	6	(drop droplet) with laser with gasif$9	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/31 09:40
S32	5	"2003049369"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:01
S33	5	S32	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 12:59
S34	2	"2003-049369"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:01
S35	6	S31 and ((drop droplet) with gasif$9)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:11
S36	0	"09335508".ap.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:11
S37	0	"09335508".an.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:12
S38	7	"335508".ap.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:22
S39	1	("5132248").PN.	USPAT; USOCR	OR	OFF	2006/02/24 13:38
S40	74296	hashimoto.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:25

S41	338582	takashi.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:25
S42	3917	S40 and S41	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:25
S43	1	S42 and (drop$3 with laser)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 09:35
S44	79	S40 adj S41 and drop$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:27
S45	1	"10179387".ap.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:39
S46	0	"10179387".apn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:39
S47	2	"20030030689"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:39
S48	1	S47 and laser	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:41
S49	0	S47 and (laser with transparen$9)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:41
S50	4	laser with transparen$9 with substrate with gasif$9	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:45

S51	381	laser with transparen$9 with substrate with (melt$4 liqui$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:45
S52	84	laser with transparen$9 with substrate with (evaporat$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 13:45
S53	5	S51 and S52	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 14:45
S54	18	(plural$4 near2 (drop droplet)) with (plural$4 near2 (laser beam))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/24 14:46
S55	2	(("5132248") or ("4492966")).PN.	USPAT; USOCR	OR	OFF	2006/08/08 11:03
S56	2	"20030030689"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/08 11:11
S57	2	"20040226929"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/08 11:11
S74	1	S57 and ((fix fixing) near7 drop$5) with ((first with second) with laser with gasif$7)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/08 11:24
S76	1	S57 and conduct$4 with film	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/08 11:28
S78	2	S57 and gasif$9	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/08 11:30
S81	1	S57 and (intens$9)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/08 11:30

S82	554	(drop droplet) with laser with between	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/09 12:06
S83	188	(drop droplet) near5 between with laser	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/09 11:19
S84	15	((drop droplet) adj5 between) with (between adj5 (drop droplet)) with laser	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/09 11:21
S85	47	((drop droplet) adj5 between) with (between adj5 (drop droplet)) same ((laser irradiat$5 beam) near5 (drop droplet))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/09 11:31
S86	2	((drop droplet) adj5 between) with (between adj5 (drop droplet)) same ((laser irradiat$5 beam) near5 (drop droplet)) and (deposit$5 with drop$5 with (laser irradiat$5 beam))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/09 11:24
S87	6	((drop droplet) adj5 between) with (between adj5 (drop droplet)) same ((laser irradiat$5 beam) near5 (drop droplet)) and (deposit$5 with (laser irradiat$5 beam)) not S86	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/09 11:24
S88	33	S85 not S84	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/09 11:40
S89	60	(drop droplet) with laser with (wir$5 circuit line)	JPO	OR	ON	2006/08/09 11:41
S90	15	((drop droplet) with laser with (wir$5 circuit line)) and ((first second between) with (drop droplet))	JPO	OR	ON	2006/08/09 11:43
S91	55	((drop droplet) with laser) and ((first second between) with (drop droplet)) not S90	JPO	OR	ON	2006/08/09 11:44

S92	13	((drop droplet) with laser) and ((first second between) with (drop droplet)) and nozzle not S90	JPO	OR	ON	2006/08/09 11:47
S93	4	((drop droplet) with laser) and ((plural$4 first second between) with (drop droplet)) and nozzle not S90 not S92	JPO	OR	ON	2006/08/09 11:53
S101	1	("4891242").PN.	USPAT; USOCR	OR	OFF	2006/08/09 11:57
S103	14	(drop$4 with laser with (deposit$5 eject$4 plural$4 wiring nozzle))	EPO	OR	ON	2006/08/09 12:01
S104	108	(drop$4 with laser with (deposit$5 eject$4 plural$4 wiring nozzle))	JPO	OR	ON	2006/08/09 12:02
S105	11	(drop$4 with laser with (deposit$5 eject$4 plural$4 wiring nozzle)) and pattern $4	JPO	OR	ON	2006/08/09 12:02
S106	1990	(dispens$4 eject$4 discharg$4) near3 (drop droplet) with (laser energy beam) and ((drop droplet) with (wiring pattern circuit line))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/09 12:08
S107	547	((dispens$4 eject$4 discharg$4 deposit$4) near3 (drop droplet)) same ((laser energy beam) with (drop droplet) with (wiring pattern circuit line))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/09 12:14
S108	154	((dispens$4 eject$4 discharg$4 deposit$4) near3 (drop droplet)) same ((laser energy beam) with (drop droplet) with (form $5 manufactur$4 make making produc$5) with (wiring pattern circuit line))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/09 12:15
S109	75	S108 and ((first second multiple plural$4) near5 drop$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/09 12:16
S110	45	S108 and ((first second multiple plural$4) near5 drop$5) and ((first second multiple plural$4) near5 (laser energ$5 intens$9))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/09 12:29

S111	0	("2004/0226929").URPN.	USPAT	OR	ON	2006/08/09 12:25
S112	182650	S110/$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/09 12:31
S113	69	S112 and ((drop droplet) with laser)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/09 12:31
S114	30267	29/825-885.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/09 12:31
S115	18	S114 and ((drop droplet) with laser)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/09 12:31
S116	3	("4891242" | "5454161" | "6357111").PN. OR ("7062849").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/08/09 12:33
S117	1	"2005244203"	JPO	OR	ON	2006/08/10 08:29
S118	1	"2005081159"	JPO	OR	ON	2006/08/10 08:08
S119	2	"2004304036" "2001179167"	JPO	OR	ON	2006/08/10 08:09
S120	4	S117 S118 S119	JPO	OR	ON	2006/08/10 08:29
S121	924	metal$4 near5 deposit$4 with (second subsequent $4) near5 temperature	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 09:37
S122	79	metal$4 near5 deposit$4 with (second subsequent $4) near5 temperature near5 (reduc$4 lower$4 small$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 11:33
S123	9	S122 and laser	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 12:11

S124	0	S122 same laser	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 09:50
S125	23	drop$4 with (deposit$4 eject$4) same (laser with drop$4 with conduct$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 10:59
S126	6	metal$4 near5 deposit$4 with drop$4 with (driv$4 evaporat$4) with (laser energy heat ir radiat$4 irradiat$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 11:38
S127	16	drop$4 near5 epitax$7 with (laser energy heat ir radiat$4 irradiat$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 12:02
S128	602	(drop$4 sputter$4) near5 epitax$7 with (laser energy heat ir radiat$4 irradiat$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 11:40
S129	514	(drop$4 sputter$4) near5 epitax$7 with (laser)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 11:40
S130	197	(drop$4 sputter$4) near5 epitax$7 with (laser) with (driv$4 evaporat$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 11:41
S131	0	S130 and (drop$4 near7 conduct$5)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 11:41
S132	7	S130 and (drop$4 near7 electr$7)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 11:41
S133	2	"2002261048"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 12:02

S134	25	(laser irradiat$4) with (driv$4 evaporat$4 gasif$9) with metal$4 near3 fix$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 12:18
S135	694	(laser irradiat$4) with (driv$4 evaporat$4 gasif$9) with drop$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 12:18
S136	561	(laser irradiat$4) with (driv$4 evaporat$4 gasif$9) with drop$4 with laser	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 12:19
S137	377	(laser irradiat$4) with (driv$4 evaporat$4 gasif$9) near5 laser with drop$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 12:19
S138	377	(driv$4 evaporat$4 gasif$9) near5 laser with drop$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 12:19
S139	114	(driv$4 evaporat$4 gasif$9) near5 laser with drop$4 and ((wire wiring circuit) near5 (substrate device))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 12:23
S140	65577	"118"/$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 12:23
S141	3	S140 and laser with (drop droplet) with evaporat$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/31 12:59
S142	147808	"427"/$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 13:12
S143	11	S142 and laser with (drop droplet) with evaporat$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 13:21

S144	11	S143 and laser	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/10 13:21
S145	1	("4665492").PN.	USPAT; USOCR	OR	OFF	2006/08/11 10:26
S152	2	"20040226929"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/31 12:07
S157	1	S152 and irradiat$4 with film	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/31 12:12
S160	39	(laser ir light pulse) with (drop droplet) with (evaporat$4 exclud$3 driv$3 remov$4 irradicat$3) near3 (liquid solvent solut$5) same (wiring wired circuit)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/31 13:06
S161	16	(laser ir light) with (drop droplet) with (evaporat$4 exclud$3 driv$3 remov$4 irradicat$3) near3 (liquid solvent solut$5) same (wiring wired circuit)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/31 13:22
S162	83	(laser ir light) with (drop droplet) with (evaporat$4 exclud$3 driv$3 remov$4 irradicat$3) near3 (liquid solvent solut$5) same ((film coat$3 layer) with (drop droplet))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/31 13:24
S163	78	S162 not S161	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/31 13:23
S164	49	(laser ir light) with (drop droplet) near5 (evaporat$4 exclud$3 driv$3 remov$4 irradicat$3) near3 (liquid solvent solut$5) same ((film coat$3 layer) with (drop droplet))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/31 13:26

S165	10	laser with (drop droplet) near5 (evaporat$4 exclud$3 driv$3 remov$4 irradicat$3) near3 (liquid solvent solut$5) same ((film coat$3 layer) with (drop droplet))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/01/31 13:27
S166	11	("4665492" | "4810525" | "4997809" | "5076869" | "5132248" | "5284695" | "5314003" | "5348775" | "5372861" | "5409741" | "5688564").PN. OR ("6531191").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/01/31 13:42
S167	3	"20050201670" "20020012096" "20040135152"	US-PGPUB; USPAT; USOCR	OR	ON	2007/02/01 10:55
S168	1	("5132248").PN.	USPAT; USOCR	OR	OFF	2007/01/31 13:55
S169	0	(narrow with wide with laser with beam) same evaporat$4 same sinter$4	US-PGPUB; USPAT; USOCR	OR	ON	2007/02/01 10:58
S170	0	(wide$3 with (laser beam)) same (narrow with (laser beam)) same evaporat$4 same sinter$4	US-PGPUB; USPAT; USOCR	OR	ON	2007/02/01 10:59
S171	39	(wide$3 with (laser beam)) same (narrow with (laser beam)) same evaporat$4	US-PGPUB; USPAT; USOCR	OR	ON	2007/02/01 11:40
S172	102	(wide$3 with (laser beam)) same (narrow with (laser beam)) same diffract$4 with optic$4	US-PGPUB; USPAT; USOCR	OR	ON	2007/02/01 11:41
S173	1	(wide$3 with (laser beam)) same (narrow with (laser beam)) same diffract$4 with optic$4 same evaporat$5	US-PGPUB; USPAT; USOCR	OR	ON	2007/02/01 11:42
S174	0	((wide$3 narrow$4) near5 (laser beam)) with diffract$4 with optic$4 same evaporat$5	US-PGPUB; USPAT; USOCR	OR	ON	2007/02/01 11:43
S175	1	((wide$3 narrow$4) near5 (laser beam)) same diffract$4 with optic$4 same evaporat$5	US-PGPUB; USPAT; USOCR	OR	ON	2007/02/01 11:44
S176	14	laser with diffract$4 with optic$4 with evaporat$5	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 11:08
S177	0	laser with diffract$4 adj optic$4 with evaporat$5	US-PGPUB; USPAT; USOCR	OR	ON	2007/02/01 11:45

S178	0	laser with diffract$4 adj optic$4 same laser with evaporat$5	US-PGPUB; USPAT; USOCR	OR	ON	2007/02/01 11:46
S179	30	laser with diffract$4 adj optic$4 and laser with evaporat$5	US-PGPUB; USPAT; USOCR	OR	ON	2007/02/01 11:45
S180	1	laser with diffract$4 adj optic$4 same laser with decompos$7	US-PGPUB; USPAT; USOCR	OR	ON	2007/02/01 11:47
S181	370	(laser same (diffract$4 adj optic$4 adj element)) and (laser with (decompos$7 evaporat$4 burn$4 eliminat $4 sublimat$4 remov$4))	US-PGPUB; USPAT; USOCR	OR	ON	2007/02/01 11:49
S182	50	(laser same (diffract$4 adj optic$4 adj element)) same (laser with (decompos$7 evaporat$4 burn$4 eliminat$4 sublimat $4 remov$4))	US-PGPUB; USPAT; USOCR	OR	ON	2007/02/01 11:50
S183	20	(laser same (diffract$4 adj optic$4 adj element)) with (laser with (decompos$7 evaporat$4 burn$4 eliminat $4 sublimat$4 remov$4))	US-PGPUB; USPAT; USOCR	OR	ON	2007/02/01 11:50
S184	2	(("6531191") or ("3710072")).PN.	USPAT; USOCR	OR	OFF	2008/01/17 12:09
S185	1	S184 and sinter$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 11:26
S186	399562	"427"/$.ccls. "264"/$.ccls. "156"/$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 11:55
S187	12	"0930641"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 11:56
S188	14	"801698"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/08/01 12:03
S189	3	(("5132248") or ("4891242") or ("3982251")).PN.	USPAT; USOCR	OR	OFF	2007/08/01 12:04

S190	58	("4088799" | "4297782" | "4299860" | "4349408" | "4493143" | "4495255" | "4511600" | "4526807" | "4560580" | "4568411"). PN. OR ("5132248").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 12:08
S191	23	S190 and drop$4 with (laser light)	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 12:15
S192	23	S190 and drop$4 with (laser light) and heat$4	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 12:16
S193	23	S190 and drop$4 with (laser light) and (heat$4 evaporat$4)	US-PGPUB; USPAT; USOCR	OR	ON	2007/08/01 12:28
S199	1	("6596462").PN.	USPAT; USOCR	OR	OFF	2007/08/01 12:53
S200	1740	first with second with third with (between inbetween) with drop$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:09
S201	333	first with second with third near2 (between inbetween) with drop$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:10
S202	0	first with second with third near2 (between inbetween) with drop$3 same deposit$3 with substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:10
S203	49	first with second with third near2 (between inbetween) with drop$3 same line$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:14
S204	3	first with second with third near2 (between inbetween) with droplet same line$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:14
S205	1	first with second with third near2 (between inbetween) with droplet with (deposit$4 apply$4 build$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:18
S206	2	first with second with third near2 (between inbetween) with droplet same droplet with (deposit $4 apply$4 build$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:20

S207	1	first with second with third near2 (between inbetween) with droplet same droplet near3 (deposit$4 apply$4 build $3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:19
S208	4	first with second with droplet same third near2 (between inbetween) same droplet with (deposit$4 apply$4 build$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:21
S209	15	first with second with drip same third near2 (between inbetween)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:23
S210	7	first with second with deposit$3 near3 (liquid paste drop$3 drip$3) same third near3 (between inbetween) with (liquid paste drop$3 drip$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:28
S211	614	first with second with deposit$3 with third near3 (between inbetween)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:29
S212	3251	first with second with (deposit$3 plac$5) with third near3 (between inbetween)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:29
S213	75	first with second with (deposit$3 plac$5) with third near3 (between inbetween) with gap	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:30
S214	16	first with second with (deposit$3 plac$5) with third near3 (between inbetween) with gap not layer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:32
S215	178	droplet with fill$3 near2 gap	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:33
S216	87	droplet with fill$3 adj gap	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:33

S217	33	droplet near5 fill$3 adj gap	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:34
S218	0	droplet near5 fill$3 adj gap with deposit$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:34
S219	0	droplet near5 fill$3 adj gap with build$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:34
S220	0	droplet near5 fill$3 adj gap same build$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:35
S221	0	droplet near5 fill$3 adj gap same (build$3 deposit$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:35
S222	3	(droplet drop drip) near5 fill$3 adj gap same (build$3 deposit$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 12:36
S223	7	(droplet drop drip) with fill$3 adj gap same (build$3 deposit$3) not S222	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 13:02
S224	1	(droplet drop drip) with fill$3 adj gap same (build$3 deposit$3) not S222 and wiring	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 13:02
S225	21	S216 and wiring	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 13:02
S226	14	S216 and wiring with substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 13:03

S227	3	S226 and gasif$7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 13:04
S228	3	S216 and gasif$7	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/01/17 13:04
S229	3	(("5316800") or ("6531191") or ("3710072")).PN.	USPAT; USOCR	OR	OFF	2008/04/16 09:06
S230	2	"20040226929"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/16 10:23
S231	1	S230 and droplet with diameter	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/16 10:23

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